



DMP31D7LQ

#### Product Summary

BV <sub>DSS</sub>	RDS(ON) Max	ID Ta = +25°C
201/	0.9Ω @ Vgs = -10V	-0.58A
-30V	1.7Ω @ V <sub>GS</sub> = -4.5V	-0.42A

#### Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## Applications

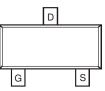
- **DC-DC converters**
- Power management functions



SOT23

**ESD Protected Gate** 

**Top View** 



Top View Internal Schematic

Equivalent Circuit

## Ordering Information (Note 4)

Part Number	Backaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMP31D7LQ-7	SOT23	3000	Tape & Reel	
DMP31D7LQ-13	SOT23	10,000	Tape & Reel	

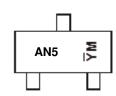
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



AN5 = Product Type Marking Code YM = Date Code Marking  $\overline{Y}$  = Year (ex: J = 2022) M = Month (ex: 9 = September)

#### Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	К	L	М	Ν	0	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP31D7LQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish-Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)

Gate Protection S Diode

G



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	-30	V
Gate-Source Voltage			VGSS	±20	V
Continuous Drain Current (Note 5) $V_{GS}$ = -4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-0.58 -0.46	А
Maximum Continuous Body Diode Forward Current	ls	-0.52	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	ldм	-2.5	A		

#### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		PD	0.43	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	290	°C/W
Total Power Dissipation (Note 5)		PD	0.46	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	270	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

#### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	•			•		•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	—	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	—	_	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	_	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						·
Gate Threshold Voltage	VGS(TH)	-1	_	-2.6	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
Static Drain-Source On-Resistance	D	_	0.4	0.9	Ω	$V_{GS} = -10V, I_D = -0.42A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	0.7	1.7	12	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.2A
Diode Forward Voltage	Vsd	_	-0.8	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -0.23A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	19	—	pF	
Output Capacitance	Coss	—	16	—	pF	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	3	—	pF	
Gate Resistance	Rg	—	729	—	Ω	$V_{DS} = V_{GS} = 0V$ , f = 1.0MHz
Total Gate Charge	Qg	—	0.36	—	nC	
Gate-Source Charge	Qgs	_	0.1	_	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V Ip = -250mA
Gate-Drain Charge	Qgd	_	0.1	_	nC	10 = -23011A
Turn-On Delay Time	td(on)		30		ns	
Turn-On Rise Time	tR	_	74	—	ns	V <sub>DD</sub> = -10V, V <sub>GS</sub> = -4.5V R <sub>L</sub> = 47Ω, R <sub>G</sub> = 10Ω
Turn-Off Delay Time	tD(OFF)		28	_	ns	$R_L = 47\Omega, R_G = 10\Omega$ $I_D = -200 \text{mA}$
Turn-Off Fall Time	t⊧	_	31	_	ns	

Notes:

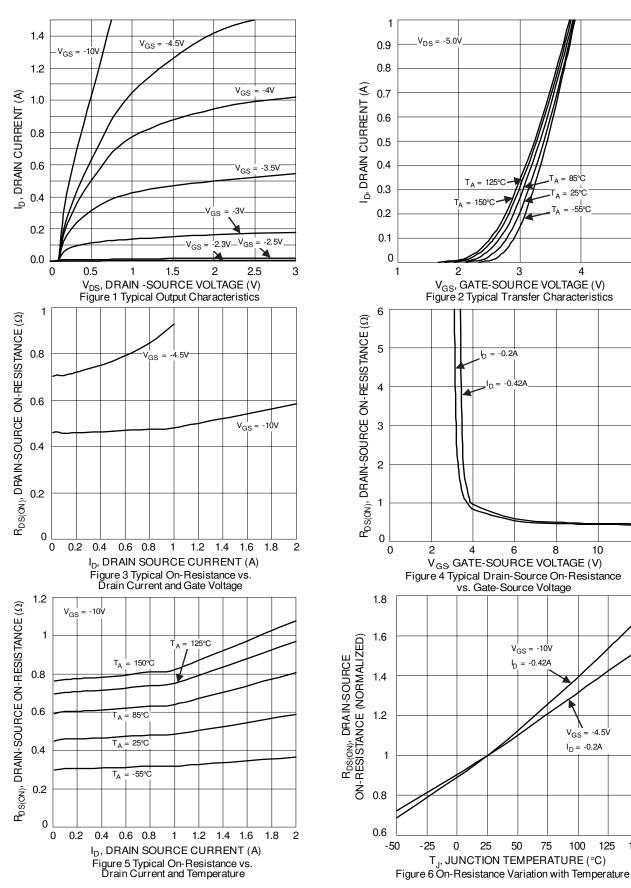
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.



### DMP31D7LQ

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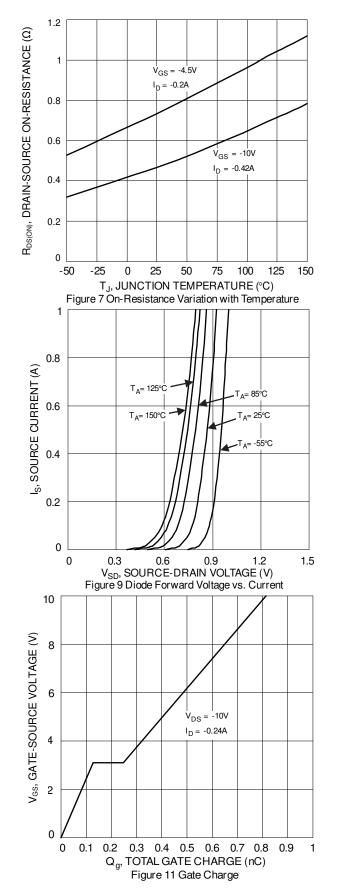
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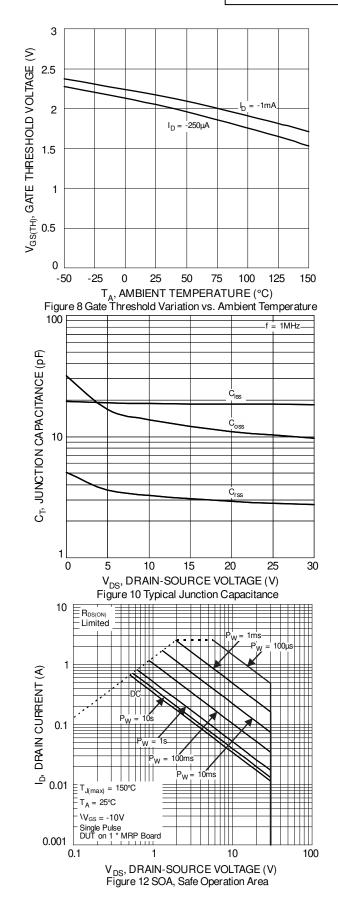


DMP31D7LQ Document number: DS43825 Rev. 2 - 2 150

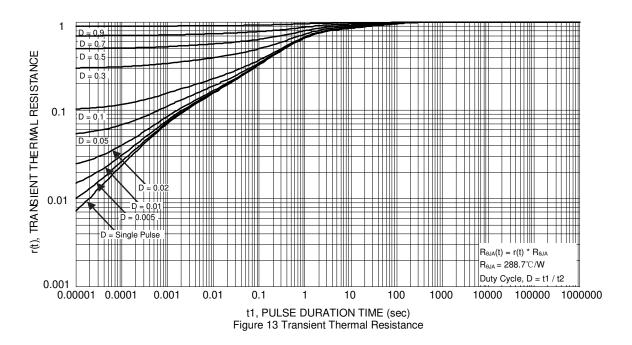
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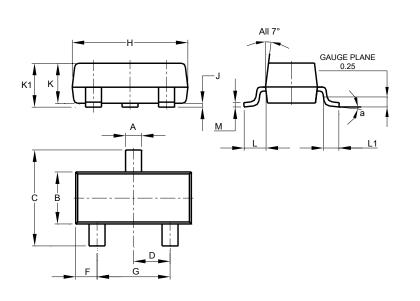






# Package Outline Dimensions

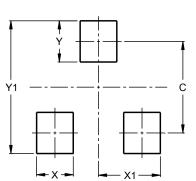
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
К	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All	Dimens	ions in	mm		

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



so	T23	

SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

nensions



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